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**PATENT REEL: 015100 FRAME: 0564** 

## **ASSIGNMENT**

WHEREAS, We, as a below named inventors, residing at the addresses stated next to our names, are joint inventors of certain new and useful improvements in an

## ENVIRONMENT-SENSITIVE LUMINESCENT DIMINE-PLATINUM BINUCLEAR COMPLEXES

for which application for Letters Patent of the United States of America was executed by us;

AND WHEREAS, Japan Science and Technology Corporation, a Japanese corporation with offices at 1-8, Honcho 4-chome, Kawaguchi-shi, Saitama 332-0012 JAPAN, (hereinafter referenced as ASSIGNEES) is/are desirous of acquiring in equal shares all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we as joint inventors as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and we hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the ASSIGNEES of the whole right, title and interest thereto:

AND We further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or their designee, as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to us and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said

PATENT REEL: 015100 FRAME: 0565 invention, applications and Letters Patent of the United States and countries foreign thereto;

AND We further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for our aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at their own expense;

AND We further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to us and will testify as to the same in any interference or litigation related thereto;

AND We hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

AND We hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number:

, Filing Date:

This assignment executed on the dates indicated below.

**RECORDED: 11/03/2003** 

Masako KATO Masabo Kato
Signature

August 21, 2003

**PATENT** REEL: 015100 FRAME: 0566